



High-Accuracy, High-Side Current Monitors in SOT23

MAX4004/MAX4006

General Description

The MAX4004/MAX4006 precision, high-side, current monitors are specifically designed for monitoring photodiode current in fiber applications. They offer a connection point for the reference current and a monitor output that produces a signal proportional to the reference current. The monitor output of the MAX4004 is a current proportional to the reference current. The monitor output of the MAX4006 is a voltage proportional to the reference current. The current monitors have six decades of dynamic range and monitor reference current of 250nA to 2.5mA with better than 5% accuracy. The photodiode current can be monitored from 10nA to 10mA with reduced accuracy.

The MAX4004/MAX4006 accept a +2.7V to +22V supply voltage, suitable for PIN photodiode applications. (For higher voltage applications, refer to the MAX4007/MAX4008 data sheet.) Internal current limiting (20mA, typ) protects the device against short-circuit-to-ground or excessive current conditions. A clamp diode protects the monitor output from overvoltage. Additionally, these devices feature thermal shutdown if the die temperature reaches +150°C.

The MAX4004/MAX4006 are available in tiny, space-saving 6-pin SOT23 and 8-pin thin QFN packages, and operate over the extended temperature range of -40°C to +85°C.

Applications

Photodiode Current-Monitoring Systems
Portable Instrumentation
Medical Instrumentation
Laboratory Instrumentation
Consumer Electronics
Current-to-Voltage Conversion
Level Translation

Selector Guide

PART	PIN-PACKAGE	INTERNAL RESISTOR	TYPICAL ACCURACY
MAX4004EUT-T	6 SOT23-6	None	5%
MAX4004ETA	8 Thin QFN	None	5%
MAX4006EUT-T	6 SOT23-6	10k Ω	1%
MAX4006ETA	8 Thin QFN	10k Ω	1%

Typical Operating Circuit appears at end of data sheet.

Features

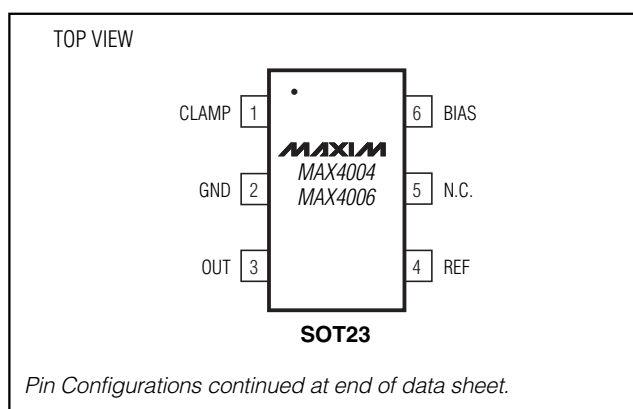
- ◆ Wide Reference Current Dynamic Range
Guaranteed 250nA to 2.5mA with 5% Accuracy
Extended 10nA to 10mA with 10% Monitor Accuracy
- ◆ Current (MAX4004) or Voltage (MAX4006) Monitor Output
- ◆ Reference Current-Limit Protection (20mA, typ)
- ◆ Voltage Clamp Protects Subsequent Output Circuitry
- ◆ +2.7V to +22V Wide Voltage Range Operation
- ◆ 6-Pin SOT23 and 8-Pin Thin QFN Packages

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX4004EUT-T	-40°C to +85°C	6 SOT23-6	ABNL
MAX4004ETA	-40°C to +85°C	8 Thin QFN-EP*	AGC
MAX4006EUT-T	-40°C to +85°C	6 SOT23-6	ABNN
MAX4006ETA	-40°C to +85°C	8 Thin QFN-EP*	AGE

*EP = Exposed pad.

Pin Configurations



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ABSOLUTE MAXIMUM RATINGS

CLAMP to GND-0.3V to +25V
 BIAS, REF to GND-0.3V to +25V
 OUT to GND-0.3V to (V_{CLAMP} + 0.6V)
 Short-Circuit, REF to GND.....Continuous
 Current into any Pin±30mA
 Continuous Power Dissipation (T_A = +70°C)
 6-Pin SOT23 (derate 8.7mW/°C above +70°C).....696mW
 8-Pin Thin QFN (derate 24.4mW/°C above +70°C) ...1951mW

Operating Temperature Range-40°C to +85°C
 Junction Temperature+150°C
 Storage Temperature Range-65°C to +150°C
 Lead Temperature (soldering, 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{BIAS} = 5V, GND = 0V, REF = Open, V_{OUT} = 0V (MAX4004), CLAMP = Open, T_A = -40°C to +85°C. Typical values are at T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Bias Voltage Range	V _{BIAS}	Inferred from power-supply rejection test		2.7		22	V
Bias Quiescent Current	I _{BIAS}	I _{REF} = 250nA			40	100	μA
		I _{REF} = 2.5mA			3.6	4	mA
Reference Voltage	V _{REF}	I _{REF} = 2.5mA		V _{BIAS} - 1.1	V _{BIAS} - 0.8		V
Thermal Shutdown Engage Temperature	T _{SHDN}	REF shorted to GND, junction temperature rising			150		°C
Trip-Point Temperature Hysteresis	T _{HYS}	REF shorted to GND, junction temperature falling			5		°C
Input Current Limit	I _{LIM}	V _{REF} = V _{BIAS} - 5V			20		mA
MAX4004 Output Current Noise	i _{NOUT}	f = 0.1Hz to 10Hz	I _{REF} = 250nA		0.3		pA _{RMS}
			I _{REF} = 2.5mA		63		
		f = 0.1Hz to 10kHz	I _{REF} = 250nA		9.2		
			I _{REF} = 2.5mA		1240		
MAX4006 Output Voltage Noise	e _{NOUT}	f = 0.1Hz to 10Hz	I _{REF} = 250nA		0.041		μV _{RMS}
			I _{REF} = 2.5mA		0.63		
		f = 0.1Hz to 10kHz	I _{REF} = 250nA		1.3		
			I _{REF} = 2.5mA		12.5		
Output Resistance	R _{OUT}	MAX4004	I _{REF} = 250nA		50		GΩ
			I _{REF} = 2.5mA		5		MΩ
		MAX4006			10		kΩ
Output Leakage		REF = open			1		pA
Output Voltage Range	V _{OUT}	V _{BIAS} = 2.7V to 22V, I _{REF} = 0 to 1mA, MAX4004: ΔI _{OUT} /I _{OUT} = ±1%, MAX4006: ΔV _{OUT} /I _{OUT} = ±1%		0 to V _{BIAS} - 1.5	0 to V _{BIAS} - 0.85		V

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MAX4004/MAX4006

ELECTRICAL CHARACTERISTICS (continued)

($V_{BIAS} = 5V$, $GND = 0V$, $REF = Open$, $V_{OUT} = 0V$ (MAX4004), $CLAMP = Open$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$. Typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 1)

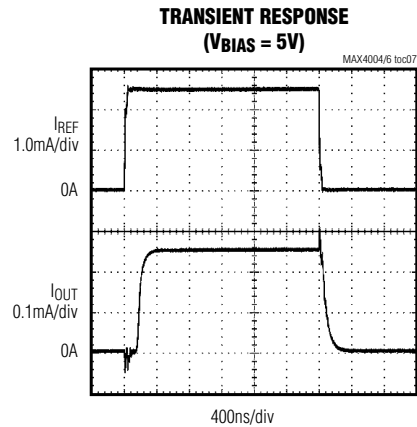
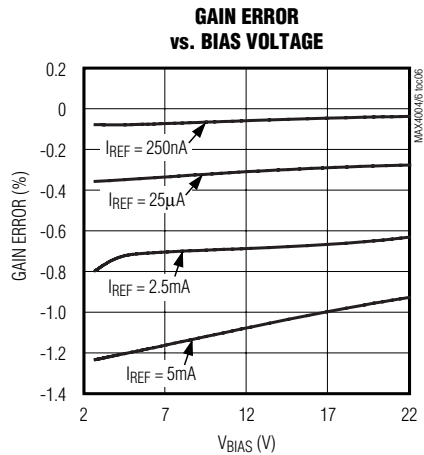
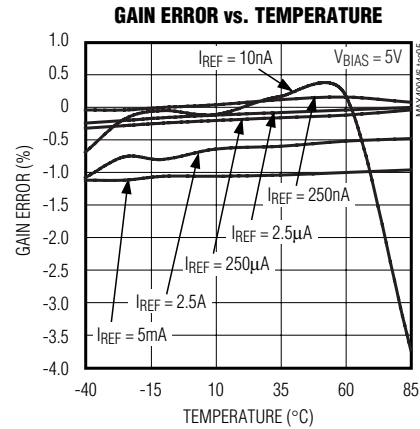
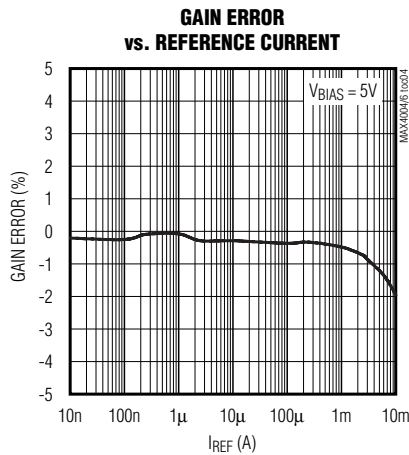
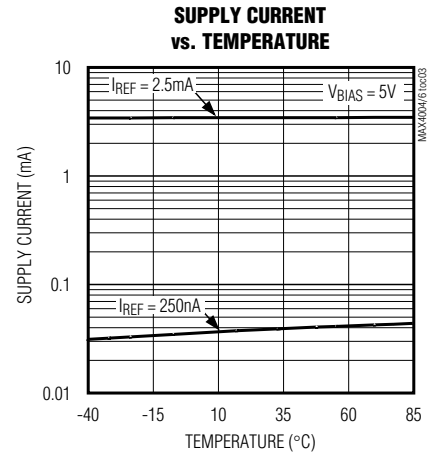
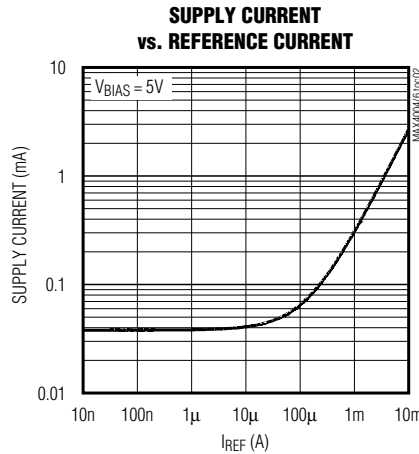
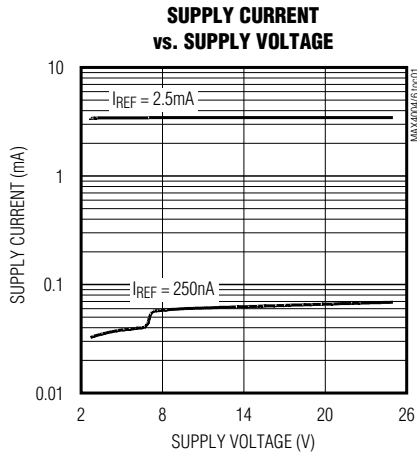
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Output Clamp Voltage	$V_{OUT} - V_{CLAMP}$				0.6		V
Output Clamp Leakage		$V_{CLAMP} = 0$ to $22V$			1		pA
MAX4004 Current Gain	I_{OUT}/I_{REF}	$I_{REF} = 250nA$		0.09	0.099	0.11	mA/mA
		$I_{REF} = 2.5mA$		0.094	0.095	0.106	
		$I_{REF} = 10mA$, $V_{BIAS} = 12V$			0.098		
MAX4006 Transimpedance Gain	V_{OUT}/I_{REF}	$I_{REF} = 250nA$		0.9	0.995	1.1	V/mA
		$I_{REF} = 2.5mA$		0.95	0.998	1.05	
		$I_{REF} = 10mA$, $V_{BIAS} = 12V$			0.992		
Power-Supply Rejection Ratio (PSRR)	$(\Delta I_{OUT}/I_{OUT})/\Delta V_{BIAS}$	MAX4004: $V_{BIAS} = 2.7V$ to $22V$	$I_{REF} = 250nA$		50	1000	ppm/V
			$I_{REF} = 1mA$		50	1000	
	$(\Delta V_{OUT}/V_{OUT})/\Delta V_{BIAS}$	MAX4006: $V_{BIAS} = 2.7V$ to $22V$	$I_{REF} = 1mA$		50	1000	
Power-Up Settling Time	t_s	I_{OUT} settles within 0.1%, $C_{IN} = 10nF$ between REF and GND	$I_{REF} = 250nA$		7.5		ms
			$I_{REF} = 2.5mA$		90		μs

Note 1: All devices are 100% tested at room temperature ($T_A = +25^{\circ}C$). All temperature limits are guaranteed by design.

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Typical Operating Characteristics

($T_A = +25^\circ\text{C}$, unless otherwise noted.)



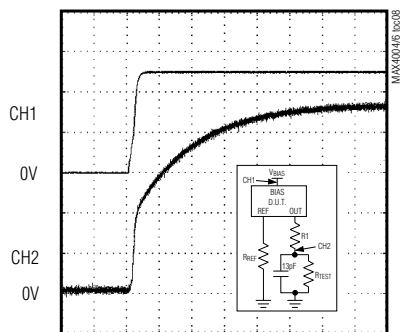
High-Accuracy, High-Side Current Monitors in SOT23

Typical Operating Characteristics (continued)

($T_A = +25^\circ\text{C}$, unless otherwise noted.)

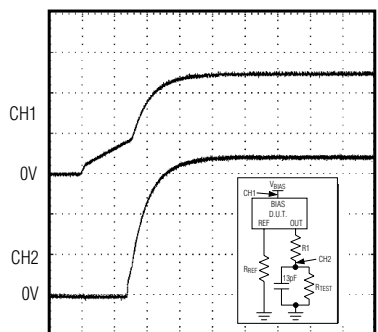
MAX4004/MAX4006

STARTUP DELAY
($V_{\text{BIAS}} = 5\text{V}$, $I_{\text{REF}} = 250\text{nA}$)



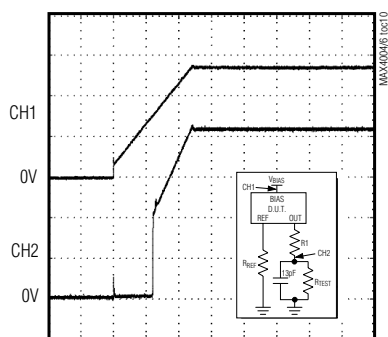
$R_{\text{REF}} = 16.8\text{M}\Omega$
 $R_1 = 118\text{M}\Omega$
 $R_{\text{TEST}} = 1.67\text{M}\Omega$
CH1: 2V/div
CH2: 10mV/div

STARTUP DELAY
($V_{\text{BIAS}} = 5\text{V}$, $I_{\text{REF}} = 2.5\text{mA}$)



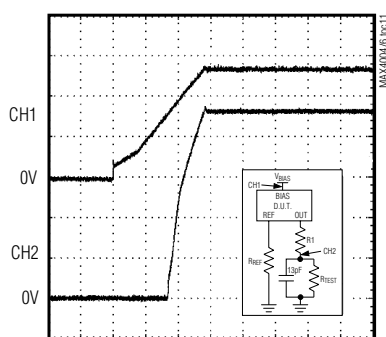
$R_{\text{REF}} = 1.68\text{k}\Omega$
 $R_1 = 0\Omega$
 $R_{\text{TEST}} = 14.0\text{k}\Omega$
CH1: 2V/div
CH2: 1V/div

STARTUP DELAY
($V_{\text{BIAS}} = 2.7\text{V}$, $I_{\text{REF}} = 250\text{nA}$)



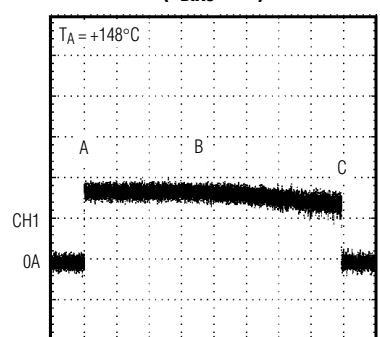
$R_{\text{REF}} = 8.8\text{M}\Omega$
 $R_1 = 0\Omega$
 $R_{\text{TEST}} = 8.1\text{M}\Omega$
CH1: 1V/div
CH2: 50mV/div

STARTUP DELAY
($V_{\text{BIAS}} = 2.7\text{V}$, $I_{\text{REF}} = 2.5\text{mA}$)



$R_{\text{REF}} = 794\Omega$
 $R_1 = 0\Omega$
 $R_{\text{TEST}} = 4.01\text{k}\Omega$
CH1: 1V/div
CH2: 200mV/div

SHORT-CIRCUIT RESPONSE
($V_{\text{BIAS}} = 5\text{V}$)

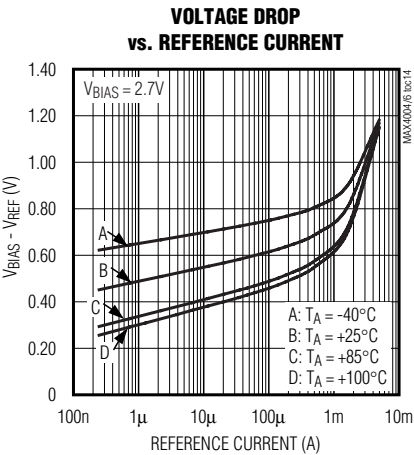
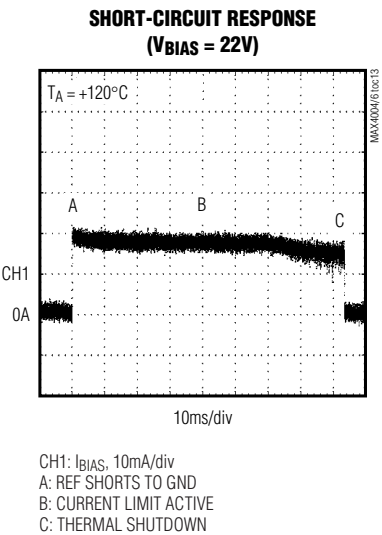


CH1: I_{BIAS} , 10mA/div
A: REF SHORTS TO GND
B: CURRENT LIMIT ACTIVE
C: THERMAL SHUTDOWN

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Typical Operating Characteristics (continued)

(T_A = +25°C, unless otherwise noted.)

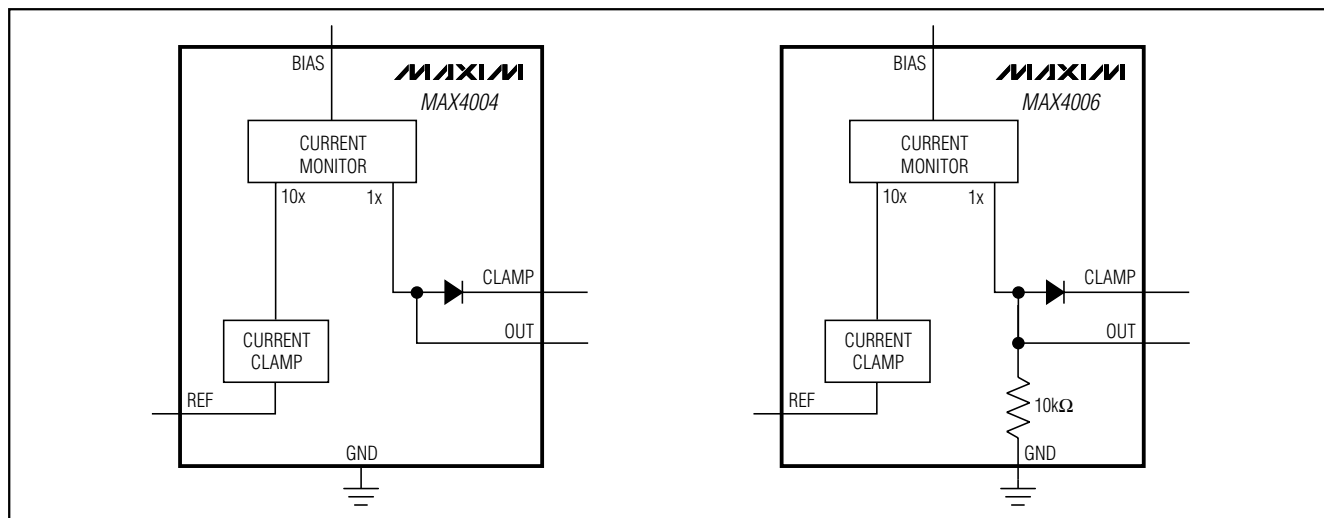


Pin Description

PIN				NAME	FUNCTION
MAX4004		MAX4006			
SOT23	Thin QFN	SOT23	Thin QFN		
1	5	1	5	CLAMP	Clamp Voltage Input. External potential used for voltage clamping of V _{OUT} .
2	3	2	3	GND	Ground
3	4	—	—	OUT	Current-Monitor Output. OUT sources a current of 1/10th I _{REF} .
4	1	4	1	REF	Reference Current Output. REF provides the source current to the cathode of the photodiode.
5	2, 6, 7	5	2, 6, 7	N.C.	No Connection. Not internally connected.
6	8	6	8	BIAS	Bias Voltage Input. Bias voltage for photodiode.
—	—	3	4	OUT	Current-Monitor Output. OUT presents a voltage proportional to I _{REF} at 1V/mA. An internal 10kΩ resistor connects OUT to GND (see <i>Functional Diagram</i>).

High-Accuracy, High-Side Current Monitors in SOT23

Functional Diagrams



MAX4004/MAX4006

Detailed Description

The MAX4004/MAX4006 are versatile current monitors intended for monitoring DC photodiode current in fiber applications (see the *Functional Diagram*). The MAX4004 output is a current that is exactly one-tenth of the reference current. The MAX4006 outputs a voltage that is proportional to the reference current with a transimpedance gain of 1V/mA achieved by a factory-trimmed, internal 10kΩ resistor.

Both current devices have six decades of dynamic range and monitor reference current ranging from 250nA to 2.5mA, the nominal operating range, with better than 5% accuracy across the entire reference current, bias voltage, and temperature ranges. The corresponding monitor outputs produce 25nA to 0.25mA (MAX4004) and 0.25mV to 2.5V (MAX4006). When the reference currents are extended to the broader range of 10nA to 10mA, an accuracy of less than 10% is maintained. Internal current limiting (20mA, typ) protects the device against short-circuit-to-ground conditions, and a thermal shutdown feature reduces both the reference current and the monitor current to zero if the die temperature reaches +150°C.

The MAX4004/MAX4006 accept a +2.7V to +22V supply voltage, suitable for PIN photodiode applications. A clamping diode, shown in the *Functional Diagram*, is provided to protect subsequent output circuitry from an overvoltage condition.

Applications Information

Clamping the Monitor Output Voltage

CLAMP provides a means for diode clamping the voltage at OUT, thus V_{OUT} is limited to $V_{CLAMP} + 0.6V$. CLAMP can be connected to either an external supply, to BIAS, or can be left floating if voltage clamping is not required.

Using PIN Photodiodes in Fiber Applications

When using the MAX4004/MAX4006 to monitor PIN photodiode currents in fiber applications, several issues must be addressed. In applications where the photodiode must be fully depleted, keep track of voltages budgeted for each component with respect to the available supply voltage(s). The current monitor requires as much as 1.2V between BIAS and REF, which must be considered as part of the overall voltage budget.

Additional voltage margin can be created if a negative supply is used in place of a ground connection, as long as the overall voltage drop experienced by the MAX4004/MAX4006 is less than or equal to 22V. For this type of application, the MAX4004 is suggested so the output can be referenced to “true” ground and not the negative supply. The MAX4004’s output current can be referenced as desired with either a resistor to ground or a transimpedance amplifier. Take care to ensure that output voltage excursions do not interfere with the required margin between BIAS and OUT.

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In many fiber applications, OUT is connected directly to an ADC that operates from a supply voltage that is less than the voltage at BIAS. Connecting the MAX4004/MAX4006's clamping diode output, CLAMP, to the ADC power supply helps avoid damage to the ADC. Without this protection, voltages can develop at OUT that can destroy the ADC. This protection is less critical when OUT is connected directly to subsequent transimpedance amplifiers (linear or logarithmic) that have low-impedance, near-ground-referenced inputs. If a transimpedance amp is used on the low side of the photodiode, its voltage drop must also be considered. Leakage from the clamping diode is most often insignificant over nominal operating conditions, but grows with temperature.

To maintain low levels of wideband noise, lowpass filtering the output signal is suggested in applications where only DC measurements are required. Determining the required filtering components is straightforward, as the MAX4004 exhibits a very high output impedance ($>5\text{M}\Omega$), while the MAX4006 exhibits an output resistance of $10\text{k}\Omega$.

In some applications where pilot tones are used to identify specific fiber channels, higher bandwidths are desired at OUT to detect these tones. Consider the minimum and maximum currents to be detected, then consult the frequency response and noise typical operating curves. If the minimum current is too small, insufficient monitor bandwidth could result, while too high of a current could result in excessive monitor noise across the desired bandwidth. See the MAX4009 family for devices intended for fiber applications using pilot tones.

Bypassing and External Components

In applications where power-supply noise can interfere with DC diode measurements, additional filtering is suggested. Such noise is commonly seen when switching power supplies are used to generate the photodiode bias voltage. As shown in the typical operating circuit, a pi filter (two $0.22\mu\text{F}$ capacitors and one $2.2\mu\text{H}$ inductor) greatly suppress power-supply switching noise. If such a filter is already present in the bias-generating circuit, only a simple bypass capacitor at the BIAS pin is suggested. The output lowpass filter, a $10\text{k}\Omega$ resistor and a 10nF capacitor, further reduce permeating power-supply noise as well as other wideband noise that might otherwise restrict measurements at low signal levels. Again, reducing the bandwidth of the OUT signal can affect performance of pilot-tone systems.

To restrict high-frequency photodiode signals from affecting the current monitor and BIAS power supply, an RF choke and 10nF capacitor can be added. The capacitance presented to REF should not exceed 10nF ; larger values increase startup time and could cause the thermal shutdown circuit to activate during startup.

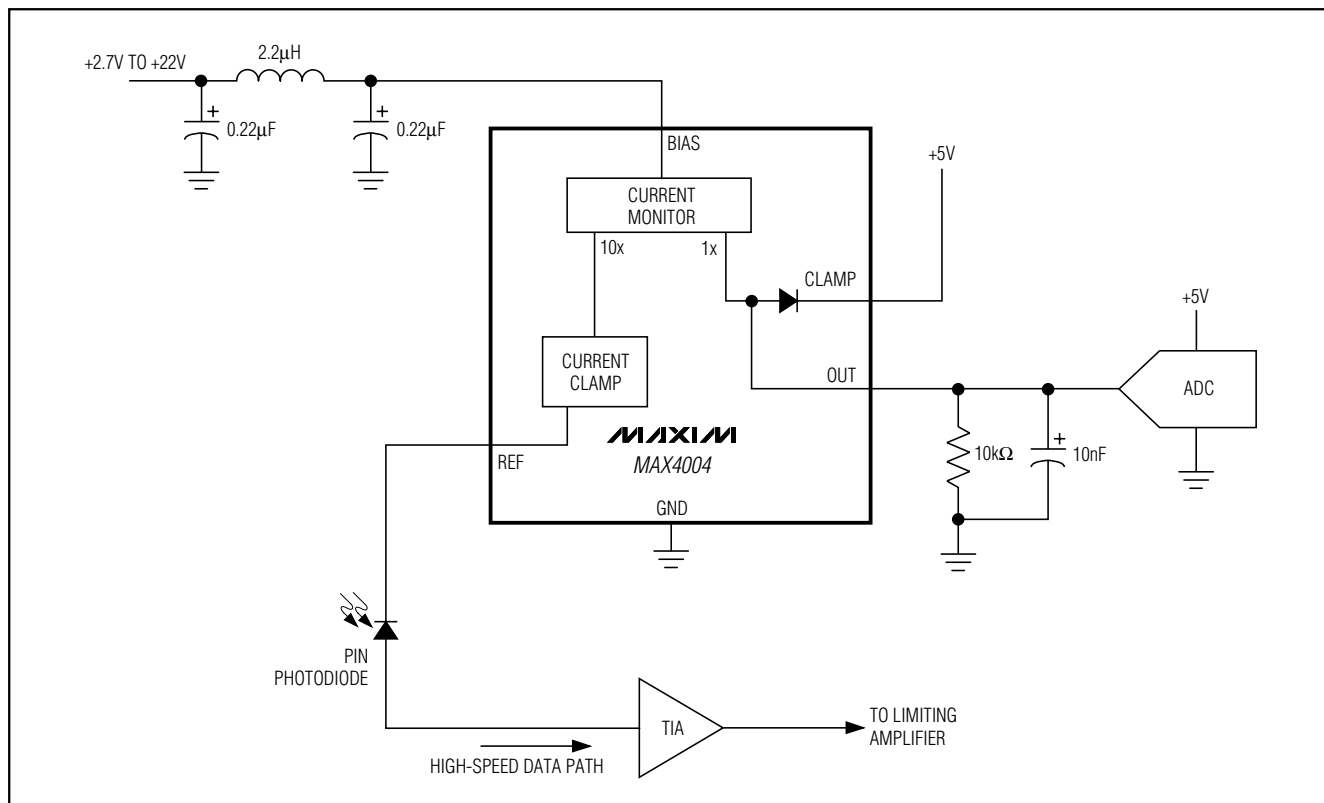
Exposed Pad

The 8-pin thin QFN package has an exposed pad on the bottom of the IC. See the package for dimensions and connect the exposed pad to GND.

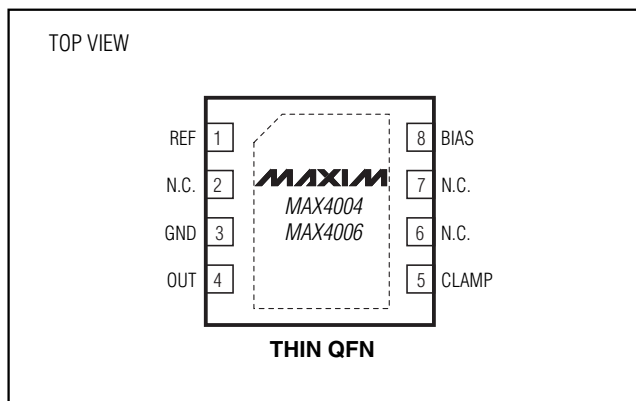
High-Accuracy, High-Side Current Monitors in SOT23

Typical Operating Circuit

MAX4004/MAX4006



Pin Configurations (continued)



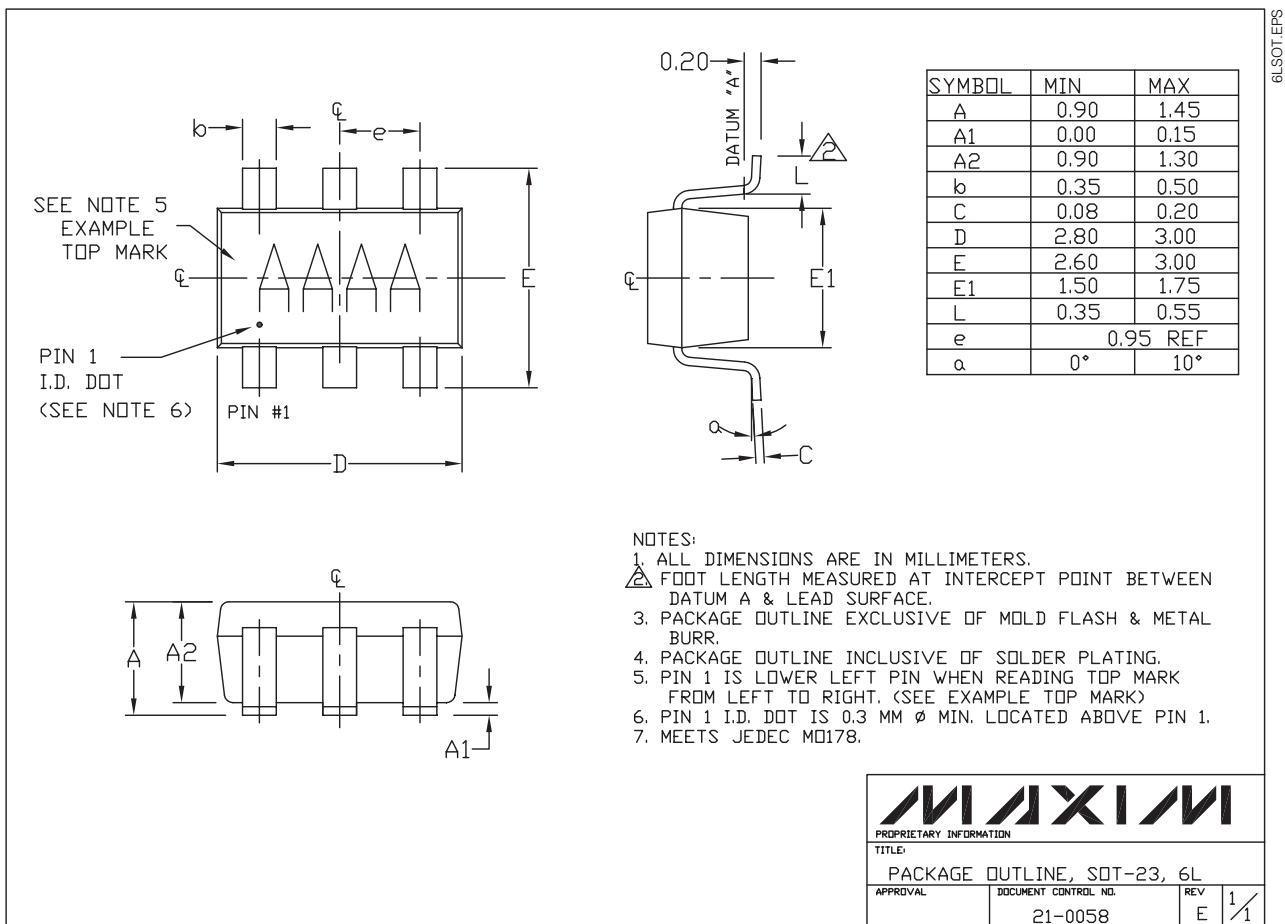
Chip Information

TRANSISTOR COUNT: 195
PROCESS: BiCMOS

High-Accuracy, High-Side Current Monitors in SOT23

Package Information

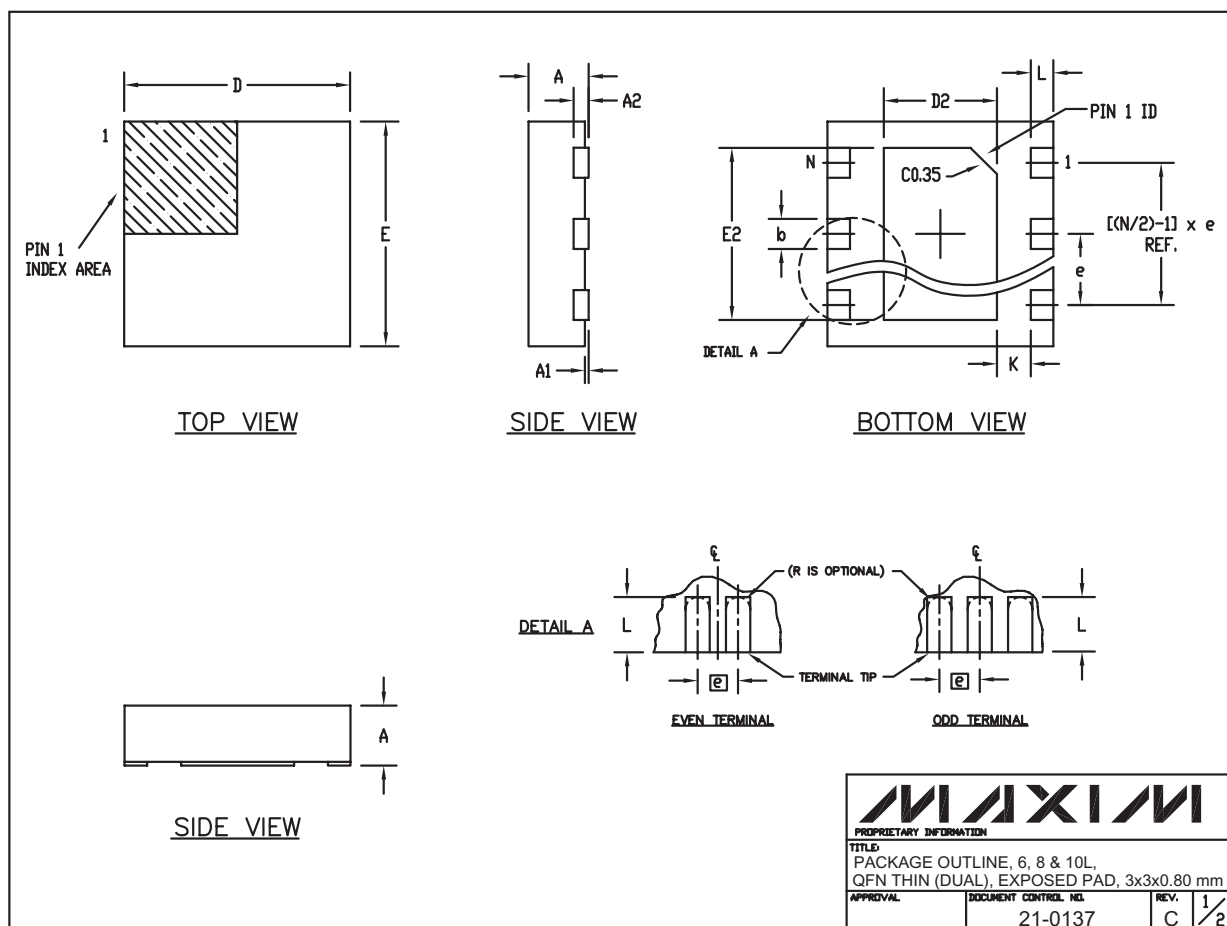
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



High-Accuracy, High-Side Current Monitors in SOT23

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



6, 8, & 10L, QFN THIN.EPS

MAX4004/MAX4006

High-Accuracy, High-Side Current Monitors in SOT23

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)

COMMON DIMENSIONS		
SYMBOL	MIN.	MAX.
A	0.70	0.80
D	2.90	3.10
E	2.90	3.10
A1	0.00	0.05
L	0.20	0.40
k	0.25 MIN	
A2	0.20 REF.	

PACKAGE VARIATIONS							
PKG. CODE	N	D2	E2	e	JEDEC SPEC	b	[(N/2)-1] x e
T633-1	6	1.50–0.10	2.30–0.10	0.95 BSC	MO229 / WEEA	0.40–0.05	1.90 REF
T833-1	8	1.50–0.10	2.30–0.10	0.65 BSC	MO229 / WEEC	0.30–0.05	1.95 REF
T1033-1	10	1.50–0.10	2.30–0.10	0.50 BSC	MO229 / WEED-3	0.25–0.05	2.00 REF

NOTES:

1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
3. WARPAGE SHALL NOT EXCEED 0.10 mm.
4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
5. DRAWING CONFORMS TO JEDEC MO220.

MAXIM			
PROPRIETARY INFORMATION			
TITLE PACKAGE OUTLINE, 6, 8 & 10L, QFN THIN (DUAL), EXPOSED PAD, 3x3x0.80 mm			
APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	C	2/2

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